

Vishay Siliconix

Dual N-Channel 30-V (D-S) MOSFET

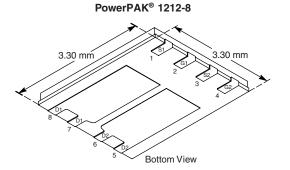
PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)			
30	0.036 at V _{GS} = 10 V	6.8	7			
	0.039 at V _{GS} = 4.5 V	6.6	1			

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- 100 % R_g Tested
- Space Savings Optimized for Fast Switching
- Compliant to RoHS Directive 2002/95/EC

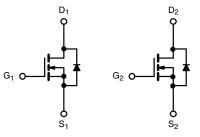
APPLICATIONS

- Synchronous Rectification
- Intermediate Driver



Ordering Information: Si7212DN-T1-E3 (Lead (Pb)-free)

Si7212DN-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET N-C

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted Symbol Parameter 10 s **Steady State** Unit Drain-Source Voltage V_{DS} 30 ٧ Gate-Source Voltage V_{GS} ± 12 T_A = 25 °C 6.8 4.9 Continuous Drain Current (T_J = 150 °C)^a I_D $T_A = 85 \ ^\circ C$ 4.9 3.5 A Pulsed Drain Current 20 IDM I_S 2.2 1.1 Continuous Source Current (Diode Conduction)^a Single Pulse Avalanche Current I_{AS} 10 А L = 0.1 mHE_{AS} Single Pulse Avalanche Energy 5 mJ T_A = 25 °C 1.3 2.6 P_D W Maximum Power Dissipation^a T_A = 85 °C 0.69 1.4 Operating Junction and Storage Temperature Range T_J, T_{stq} - 55 to 150 °C 260 Soldering Recommendations (Peak Temperature)^{b, c}

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Typical	Maximum	Unit			
	t ≤ 10 s	- R _{thJA}	38	48				
Maximum Junction-to-Ambient ^a	Steady State		77	94	°C/W			
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	4.3	5.4				

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted										
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit				
Static										
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.6		1.6	V				
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 12 V$			± 100	nA				
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	uA				
		V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C			5					
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α				
	Б	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.8 \text{ A}$		0.030	0.036	Ω				
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6.6 \text{ A}$		0.032	0.039					
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 6.8 \text{ A}$		20		S				
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = 2.2 A, $V_{\rm GS}$ = 0 V		0.8	1.2	V				
Dynamic ^b				•						
Total Gate Charge	Qg			7	11					
Gate-Source Charge	Q _{gs}	$V_{DS} = 15$ V, $V_{GS} = 4.5$ V, $I_{D} = 6.8$ A		2		nC				
Gate-Drain Charge	Q _{gd}			1.7						
Gate Resistance	Rg	f = 1 MHz	0.6	3.0	4.5	Ω				
Turn-On Delay Time	t _{d(on)}			10	15					
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		12	20					
Turn-Off Delay Time	t _{d(off)}	$\rm I_D \cong 1$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 6 Ω		30	45	ns				
Fall Time	t _f			10	15					
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.2 A, dI/dt = 100 A/μs		15	30					

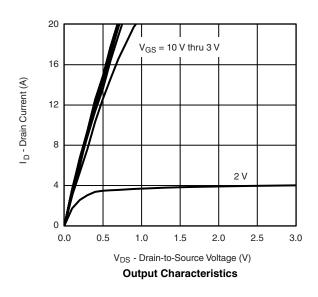
Notes:

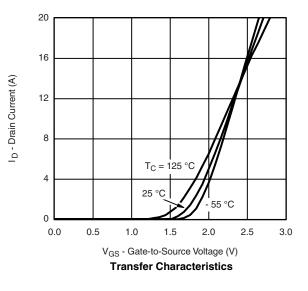
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





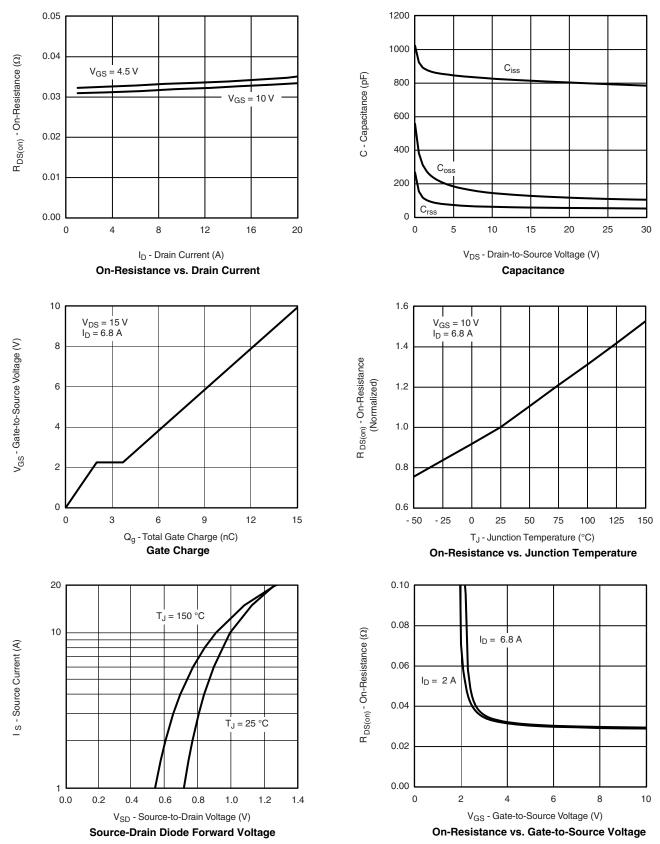
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Si7212DN

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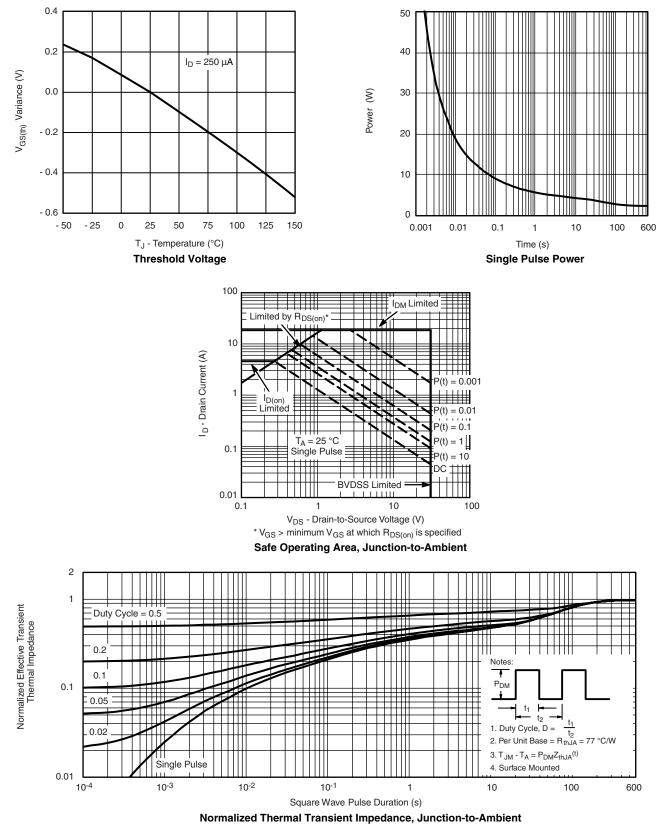


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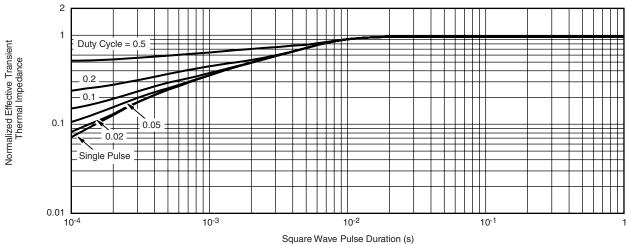
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Si7212DN

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73128.



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